

## PRELIMINARY DATA SHEET

## $\textit{XPHASE}^{\text{TM}}$ PHASE IC WITH OVP, FAULT AND OVERTEMP DETECT

## **DESCRIPTION**

The IR3086 Phase IC combined with an IR *XPhase*<sup>TM</sup> Control IC provides a full featured and flexible way to implement power solutions for the latest high performance CPUs and ASICs. The "Control" IC provides overall system control and interfaces with any number of "Phase" ICs which each drive and monitor a single phase of a multiphase converter. The *XPhase*<sup>TM</sup> architecture results in a power supply that is smaller, less expensive, and easier to design while providing higher efficiency than conventional approaches.

## **FEATURES**

- 2.5A Average Gate Drive Current
- Loss-Less Inductor Current Sense
- Internal Inductor DCR Temperature Compensation
- Programmable Phase Delay
- Programmable Feed-Forward Voltage Mode PWM Ramp
- Sub 100ns Minimum Pulse Width supports 1MHz per-phase operation
- Current Sense Amplifier drives a single wire Average Current Share Bus
- Current Share Amplifier reduces PWM Ramp slope to ensure sharing between phases
- Body Braking<sup>TM</sup> disables Synchronous MOSFET for improved transient response and prevents negative output voltage at converter turn-off
- OVP comparator with 150ns response ta Sheet 4U.com
- Phase Fault Detection
- Programmable Phase Over-Temperature Detection
- Small thermally enhanced 20L MLPQ package

## **PACKAGE PINOUT**

1 RMPIN+ VCCH 15
RMPIN- IR3086 GATEH 14
3 HOTSET PHASE PGND 13
4 VRHOT IC GATEL 11
5 ISHARE VCCL 11

DataSheet4U.com www.DataSheet4U.com

Page 1 of 15 9/1/03
DataSheet4U.com





## ORDERING INFORMATION

Device	Order Quantity
IR3086MTR	3000
IR3086M	5 per Bag

## **ABSOLUTE MAXIMUM RATINGS**

Operating Junction Temperature......150°C
Storage Temperature Range....-65°C to 150°C
ESD Rating......HBM Class 1C JEDEC standard

PIN#	PIN NAME	$V_{MAX}$	$V_{MIN}$	I <sub>SOURCE</sub>	I <sub>SINK</sub>
1	RMPIN+	20V	-0.3V	1mA	1mA
2	RMPIN-	20V	-0.3V	1mA	1mA
3	HOTSET	20V	-0.3V	1mA	1mA
4	VRHOT	20V	-0.3V	1mA	30mA
5	ISHARE	20V	-0.3V	5mA	5mA
6	SCOMP	20V <sub>DataShe</sub>	-0.3V	1mA	1mA
7	EAIN	20V	-0.3V	1mA	1mA
8	PWMRMP	20V	-0.3V	1mA	20mA
9	LGND	n/a	n/a	50mA	n/a
10	VCC	24V	-0.3V	n/a	50mA
11	VCCL	27V	-0.3V	n/a	3A for 100ns, 200mA DC
12	GATEL	27V	-0.3V DC, -2V for 100ns	3A for 100ns, 200mA DC	3A for 100ns, 200mA DC
13	PGND	0.3V	-0.3V	3A for 100ns, 200mA DC	n/a
14	GATEH	27V	-0.3V DC, -2V for 100ns	3A for 100ns, 200mA DC	3A for 100ns, 200mA DC
15	VCCH	27V	-0.3V	n/a	3A for 100ns, 200mA DC
16	CSIN+	20V	-0.3V	1mA	1mA
17	CSIN-	20V	-0.3V	1mA	1mA
18	PHSFLT	20V	-0.3V	1mA	20mA
19	DACIN	20V	-0.3V	1mA	1mA
20	BIASIN	20V	-0.3V	1mA	1mA

et4U.com

www.DataSheet4U.com

DataShee

Page 2 of 15 9/1/03

DataSheet4U.com



## **ELECTRICAL SPECIFICATIONS**

Unless otherwise specified, these specifications apply over:  $8.4V \le V_{CC} \le 14V$ ,  $6V \le V_{CCH} \le 25V$ ,  $6V \le V_{CCL} \le 14V$ , and  $0\,^{\circ}C \le T_{J} \le 125\,^{\circ}C$ ,  $C_{GATEH} = 3.3nF$ ,  $C_{GATEL} = 6.8nF$ 

PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT	
Gate Drivers						1
GATEH Rise Time	VCCH = 12V, Measure 2V to 9V transition time		22	50	ns	1
GATEH Fall Time	VCCH = 12V, Measure 9V to 2V transition time		22	50	ns	
GATEL Rise Time	VCCL = 12V, Measure 2V to 9V transition time		50	75	ns	
GATEL Fall Time	VCCL = 12V, Measure 9V to 2V transition time		50	75	ns	
GATEL low to GATEH high delay	VCCH = VCCL = 12V, Measure the time from GATEL falling to 1V to GATEH rising to 1V	10	25	50	ns	
GATEH low to GATEL high delay	VCCH = VCCL = 12V, Measure the time from GATEH falling to 1V to GATEL rising to 1V	10	25	50	ns	
Disable Pull-Down Current	Force GATH or GATEL = 2V with BIASIN = 0V	15	25	40	μА	DataShe
Current Sense Amplifier	Data Chaot 41 Lagra					
CSIN+ Bias Current	Dataoneot 10.50m	-0.5	-0.25	0	μΑ	
CSIN- Bias Current		-1	-0.4	0	μΑ	
Input Offset Voltage	CSIN+ = CSIN- = DACIN. Measure input referred offset from DACIN	-3	0.5	5	mV	
Gain at T <sub>J</sub> = 25 °C		32	34	36	V/V	1
Gain at T」= 125 °C		27	29	31	V/V	1
Slew Rate	Current Sense Amp output is an internal node. Slew rate at the ISHARE pin will be set by the internal 10kΩ resistor and any stray external capacitance		12.5		V/μs	
Differential Input Range		-20		100	mV	
Common Mode Input Range		0		4	V	
Rout at T <sub>J</sub> = 25 °C		7.9	10.5	13.1	kΩ	
Rout at T <sub>J</sub> = 125 °C		9.3	12.4	15.5	kΩ	1
Ramp Discharge Clamp						1
Clamp Voltage	Force I(PWMRMP) = 500µA. Measure V(PWMRMP) – V(DACIN)	-10	5	20	mV	
Clamp Discharge Current		4	8		mA	
Ramp Comparator						
Input Offset Voltage		20	40	80	mV	1
Hysteresis	Note 1	-10	0	10	mV	1
RMPIN+, RMPIN- Bias Current		-1	-0.5	1	μА	
Propagation Delay	VCCH = 12V. Measure time from RMPIN input (50mV overdrive) to GATEL transition to <11V.	100	150	240 www.l	ns DataShee	4U.com

et4U.com

DataSheet4U.co

Page 3 of 15

# International IOR Rectifier

**IR3086** 

PARAMETER	TEST	CONDITION .		MIN	TYP	MAX	UNIT	
PWM Comparator								
PWM Comparator Input Offset Voltage				-5	5	15	mV	
EAIN & PWMRMP Bias Current	Clamp and Curr	ent Share Adjust (	OFF	-1	-0.4	1	μА	
Propagation Delay		leasure time from t (50mV overdrive) on to < 11V.	to		70	150	ns	
Common Mode Input Range		Exceeding the Common Mode input ange results in 100% duty cycle				5	V	
Share Adjust Error Amplifier								
Input Offset Voltage				10	20	30	mV	
Input Voltage Range	EAIN – PWMRN	MP, Note 1		-3.5		3.5	V	
PWMRMP Adjust Current				4	8		mΑ	
Transconductance	I(PWMRMP) = 3	3.5mA, Note 1		0.9	1.6	2.3	A/V	
SCOMP Source/Sink Current	Note 1			20	30	40	μА	
SCOMP Activation Voltage		⊃ must increase from the until the Ramp Sequals = 10μA		60	150	300	mV	
PWMRMP Min Voltage	I(PWMRMP) =	500μΑ		150	225	350	mV	DataShee
0% Duty Cycle Comparator		•						jalasiio
Threshold Voltage	Compare to V(E	DACIN) com		88	91	94	%	
Propagation Delay	< 0.9 x V(DACII	VCCL = 12V. Measure time from EAIN < 0.9 x V(DACIN) (200mV overdrive) to GATEL transition to < 11V. Note 1.			100	150	ns	
OVP Comparator								
Threshold Voltage	Compare to V(E	DACIN)		100	125	160	mV	
Propagation Delay		easure time from ( OmV overdrive) to on to <11V.			150	250	ns	
Phase Fault Comparator								
Threshold Voltage	Compare to V(E	DACIN)		88	91	94	%	
Output Voltage	I(PHSFLT) = 4n	nA			300	400	mV	
PHSFLT Leakage Current	V(PHSFLT) = 5	.5V			0	10	μΑ	
VRHOT Comparator								
HOTSET Bias Current					-0.5	1	μΑ	
Output Voltage	I(VRHOT) = 29mA				150	400	mV	
VRHOT Leakage Current	V(VRHOT) = 5.5V				0	10	μΑ	
Threshold Hysteresis	T <sub>J</sub> ≥ 85 °C			3.0	7.0	9.0	°C	
		MIN	T	YP	M	AX		
Threshold Voltage	T <sub>J</sub> ≥ 85 °C	4.73mV/°C x T <sub>J</sub> + 1.176V		nV/°C x 1.241V		nV/°C x 1.356V	V	

et4U.com

www.DataSheet4U.com

Page 4 of 15 9/1/03

DataSheet4U.com

DataSheet4U.com

PARAMETER	TEST CONDITION	MIN	TYP	MAX	UNIT
General					
VCC Supply Current			10	14	mA
VCCL Supply Current			2.5	5	mA
VCCH Supply Current	6V ≤ V <sub>CCH</sub> ≤ 14V		5.5	8	mA
	14V ≤ V <sub>CCH</sub> ≤ 25V		6.5	10	mA
BIASIN Bias Current		-5	-2.5	2	μΑ
DACIN Bias Current		-2	-0.5	1	μΑ

Note 1: Guaranteed by design, but not tested in production

## **PIN DESCRIPTION**

PIN#	PIN SYMBOL	PIN DESCRIPTION	]
1	RMPIN+	Non-inverting input to Ramp Comparator	1
2	RMPIN-	Inverting input to Ramp Comparator	]
3	HOTSET	Inverting input to VRHOT comparator. Connect resistor divider from VBIAS to LGND to program VRHOT threshold. Diode or thermistor may be substituted for lower resistor for enhanced/remote temperature sensing.	
4	VRHOT	Open Collector output of the VRHOT comparator which drives low if IC junction temperature exceeds the user programmable limit. Connect external pull-up.	DataShe
5	ISHARE	Output of the Current Sense Amplifier and input to the Share Adjust Error Amplifier. Voltage on this pin is equal to V(DACIN) + 34 [V(CSIN+) – V(CSIN-)]. Connecting ISHARE pins creates a Share Bus enabling current sharing between Phase ICs. The Share bus is also used by the Control IC for voltage positioning and Over-Current protection.	
6	SCOMP	Compensation for the Current Share control loop. Connect a capacitor to ground to set the control loop's bandwidth.	]
7	EAIN	PWM comparator input from the Control IC. Both Gate Driver outputs drive low if the voltage on this pin is less than 91% of V(DACIN).	]
8	PWMRMP	PWM comparator ramp input. Connect a resistor from this pin to the converter input voltage and a capacitor to LGND to program the PWM ramp.	
9	LGND	Signal ground and IC substrate connection	1
10	VCC	Power for internal circuitry	1
11	VCCL	Power for Low-Side Gate Driver	1
12	GATEL	Low-Side Gate Driver Output and input to GATEH non-overlap comparator	1
13	PGND	Return for Gate Drivers	1
14	GATEH	High-Side Gate Driver Output and input to GATEL non-overlap comparator	1
15	VCCH	Power for High-Side Gate Driver	1
16	CSIN+	Non-inverting input to the Current Sense Amplifier	]
17	CSIN-	Inverting input to the Current Sense Amplifier and non-inverting input to the OVP comparator	
18	PHSFLT	Open Collector output of the Phase Fault comparator. Drives low if Phase current is unable to match the level of the SHARE bus due to an external fault. Connect external pull-up.	
19	DACIN	Reference voltage input from the Control IC and inverting input to the OVP comparator. Current sensing and PWM operation referenced to this pin.	4H com
<sup>m</sup> 20	BIASIN	System reference voltage for internal circuitry	40.00

et4U.com

DataSheet4U.co

Page 5 of 15 9/1/03

#### SYSTEM THEORY OF OPERATION

## XPhase<sup>™</sup> Architecture

The XPhase<sup>TM</sup> architecture is designed for multiphase interleaved buck converters which are used in applications requiring small size, design flexibility, low voltage, high current and fast transient response. The architecture can be used in any multiphase converter ranging from 1 to 16 or more phases where flexibility facilitates the design trade-off of multiphase converters. The scalable architecture can be applied to other applications which require high current or multiple output voltages.

As shown in Figure 1, the *XPhase*<sup>TM</sup> architecture consists of a Control IC and a scalable array of phase converters each using a single Phase IC. The Control IC communicates with the Phase ICs through a 5-wire analog bus, i.e. bias voltage, phase timing, average current, error amplifier output, and VID voltage. The Control IC incorporates all the system functions, i.e. VID, PWM ramp oscillator, error amplifier, bias voltage, and fault protections etc. The Phase IC implements the functions required by the converter of each phase, i.e. the gate drivers, PWM comparator and latch, over-voltage protection, and current sensing and sharing.

There is no unused or redundant silicon with the *XPhase*<sup>TM</sup> architecture compared to others such as a 4 phase controller that can be configured for 2, 3, or 4 phase operation. PCB Layout is easier since the 5 wire bus eliminates the need for point-to-point wiring between the Control IC and each Phase. The critical gate drive and current sense connections are short and local to the Phase ICs. This improves the PCB layout by lowering the parasitic inductance of the gate drive circuits and reducing the noise of the current sense signal.

et4U.com

Data Sheet 4 U. com

PROMER GOOD

PRIASE FAULT

VID IT 3.08.1

VOUT SENSE
VOUT SE

ataSheet4U.com

Figure 1 – System Block Diagram

Page 6 of 15 9/1/03



#### **PWM Control Method**

The PWM block diagram of the *XPhase*<sup>TM</sup> architecture is shown in Figure 2. Feed-forward voltage mode control with trailing edge modulation is used. A high-gain wide-bandwidth voltage type error amplifier in the Control IC is used for the voltage control loop. An external RC circuit connected to the input voltage and ground is used to program the slope of the PWM ramp and to provide the feed-forward control at each phase. The PWM ramp slope will change with the input voltage and automatically compensate for changes in the input voltage. The input voltage can change due to variations in the silver box output voltage or due to drops in the PCB related to changes in load current.

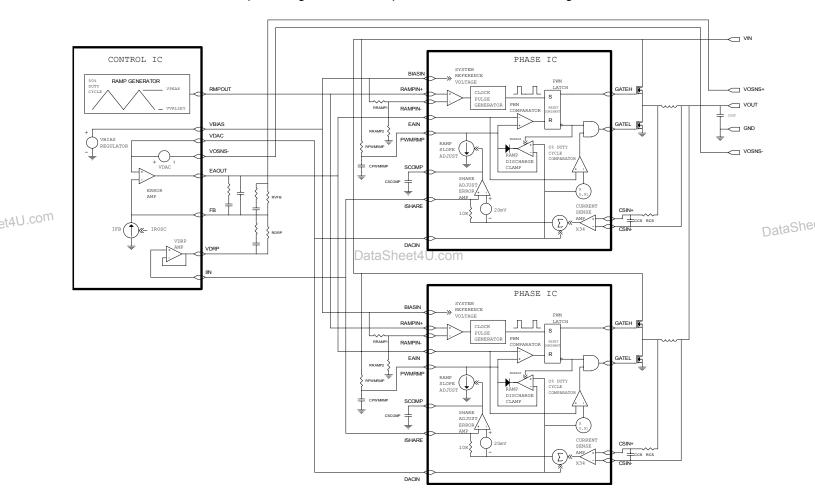


Figure 2 - PWM Block Diagram

## **Frequency and Phase Timing Control**

An oscillator with programmable frequency is located in the Control IC. The output of the oscillator is a 50% duty cycle triangle waveform with peak and valley voltages of approximately 5V and 1V. This signal is used to program both the switching frequency and phase timing of the Phase ICs. The Phase IC is programmed by resistor divider RRAMP1 and RRAMP2 connected between the VBIAS reference voltage and the Phase IC LGND pin. A comparator in the Phase ICs detects the crossing of the oscillator waveform with the voltage generated by the resistor divider and triggers a clock pulse that starts the PWM cycle. The peak and valley voltages track the VBIAS voltage reducing potential Phase IC timing errors. Figure 3 shows the Phase timing for an 8 phase converter. Note that both slopes of DataSheet4the triangle waveform can be used for synchronization by swapping the RAMP + and – pins.

Page 7 of 15

DataShee

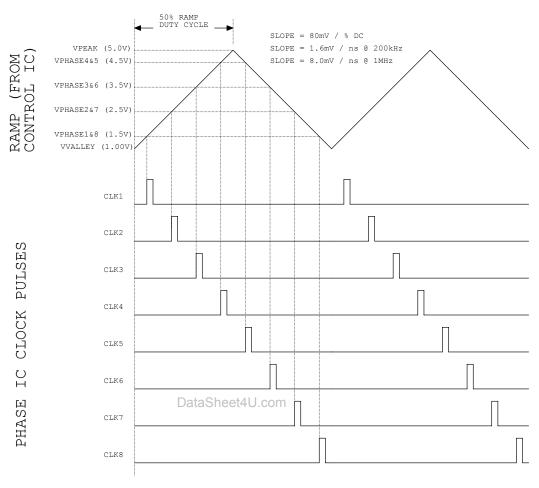


Figure 3 – 8 Phase Oscillator Waveforms

#### **PWM Operation**

et4U.com

The PWM comparator is located in the Phase IC. Upon receiving a clock pulse, the PWM latch is set, the PWMRMP voltage begins to increase, the low side driver is turned off, and the high side driver is then turned on. When the PWMRMP voltage exceeds the Error Amp's output voltage the PWM latch is reset. This turns off the high side driver, turns on the low side driver, and activates the Ramp Discharge Clamp. The clamp quickly discharges the PWMRMP capacitor to the VDAC voltage of the Control IC until the next clock pulse.

The PWM latch is reset dominant allowing all phases to go to zero duty cycle within a few tens of nanoseconds in response to a load step decrease. Phases can overlap and go to 100% duty cycle in response to a load step increase with turn-on gated by the clock pulses. An Error Amp output voltage greater than the common mode input range of the PWM comparator results in 100% duty cycle regardless of the voltage of the PWM ramp. This arrangement guarantees the Error Amp is always in control and can demand 0 to 100% duty cycle as required. It also favors response to a load step decrease which is appropriate given the low output to input voltage ratio of most systems. The inductor current will increase much more rapidly than decrease in response to load transients.

This control method is designed to provide "single cycle transient response" where the inductor current changes in response to load transients within a single switching cycle maximizing the effectiveness of the power train and minimizing the output capacitor requirements. An additional advantage is that differences in ground or input voltage at the phases have no effect on operation since the PWM ramps are referenced to VDAC.

DataSheet4U.com www.DataSheet4U.com

Page 8 of 15 9/1/03



## Body Braking<sup>™</sup>

In a conventional synchronous buck converter, the minimum time required to reduce the current in the inductor in response to a load step decrease is:

$$T_{SLFW} = [L \times (I_{MAX} - I_{MIN})] / Vout$$

The slew rate of the inductor current can be significantly increased by turning off the synchronous rectifier in response to a load step decrease. The switch node voltage is then forced to decrease until conduction of the synchronous rectifier's body diode occurs. This increases the voltage across the inductor from Vout to Vout + V<sub>BODY DIODE</sub>. The minimum time required to reduce the current in the inductor in response to a load transient decrease is now:

$$T_{SLEW} = [L \times (I_{MAX} - I_{MIN})] / (Vout + V_{BODY DIODE})$$

Since the voltage drop in the body diode is often higher than output voltage, the inductor current slew rate can be increased by 2X or more. This patent pending technique is referred to as "body braking" and is accomplished through the "0% Duty Cycle Comparator" located in the Phase IC. If the Error Amp's output voltage drops below 91% of the VDAC voltage this comparator turns off the low side gate driver.

Figure 4 depicts PWM operating waveforms under various conditions

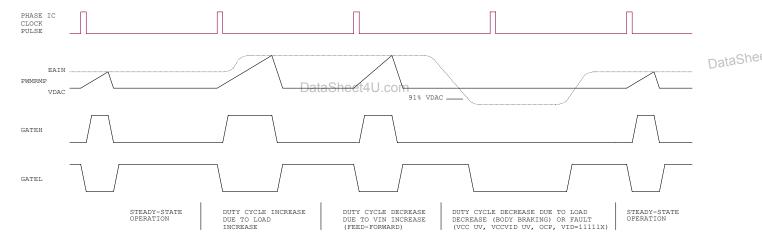


Figure 4 – PWM Operating Waveforms

## **Lossless Average Inductor Current Sensing**

Inductor current can be sensed by connecting a resistor and a capacitor in parallel with the inductor and measuring the voltage across the capacitor. The equation of the sensing network is,

$$v_C(s) = v_L(s) \frac{1}{1 + sR_S C_S} = i_L(s) \frac{R_L + sL}{1 + sR_S C_S}$$

Usually the resistor Rcs and capacitor Ccs are chosen so that the time constant of Rcs and Ccs equals the time constant of the inductor which is the inductance L over the inductor DCR. If the two time constants match, the voltage across Ccs is proportional to the current through L, and the sense circuit can be treated as if only a sense resistor with the value of RL was used. The mismatch of the time constants does not affect the measurement of inductor DC current, but affects the AC component of the inductor current.

www.DataSheet4U.com DataSheet4U.com

> Page 9 of 15 9/1/03



**IR3086** 

The advantage of sensing the inductor current versus high side or low side sensing is that actual output current being delivered to the load is obtained rather than peak or sampled information about the switch currents. The output voltage can be positioned to meet a load line based on real time information. Except for a sense resistor in series with inductor, this is the only sense method that can support a single cycle transient response. Other methods provide no information during either load increase (low side sensing) or load decrease (high side sensing).

An additional problem associated with peak or valley current mode control for voltage positioning is that they suffer from peak-to-average errors. These errors will show in many ways but one example is the effect of frequency variation. If the frequency of a particular unit is 10% low, the peak to peak inductor current will be 10% larger and the output impedance of the converter will drop by about 10%. Variations in inductance, current sense amplifier bandwidth, PWM prop delay, any added slope compensation, input voltage, and output voltage are all additional sources of peak-to-average errors.

#### **Current Sense Amplifier**

A high speed differential current sense amplifier is located in the Phase IC, as shown in figure 5. Its gain decreases with increasing temperature and is nominally 34 at 25°C and 29 at 125°C (-1470 ppm/°C). This reduction of gain tends to compensate the 3850 ppm/°C increase in inductor DCR. Since in most designs the Phase IC junction is hotter than the inductor these two effects tend to cancel such that no additional temperature compensation of the load line is required.

The current sense amplifier can accept positive differential input up to 100mV and negative up to -20mV before clipping. The output of the current sense amplifier is summed with the DAC voltage and sent to the Control IC and other Phases through an on-chip  $10K\Omega$  resistor connected to the ISHARE pin. The ISHARE pins of all the phases are ataShet tied together and the voltage on the share bus represents the total current being delivered to the load and is used by the Control IC for voltage positioning and current limit protection.

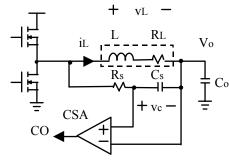


Figure 5 – Inductor Current Sensing and Current Sense Amplifier

#### **Average Current Share Loop**

Current sharing between phases of the converter is achieved by the average current share loop in each Phase IC. The output of the current sense amplifier is compared with the share bus less a 20mV offset. If current in a phase is smaller than the average current, the share adjust error amplifier of the phase will activate a current source that reduces the slope of its PWM ramp thereby increasing its duty cycle and output current. The crossover frequency of the current share loop can be programmed with a capacitor at the SCOMP pin so that the share loop does not interact with the output voltage loop.

DataSheet4U.com www.DataSheet4U.com

Page 10 of 15 9/1/03

#### **IR3086 THEORY OF OPERATION**

## **Block Diagram**

The Block diagram of the IR3086 is shown in figure 6 and specific features discussed in the following section.

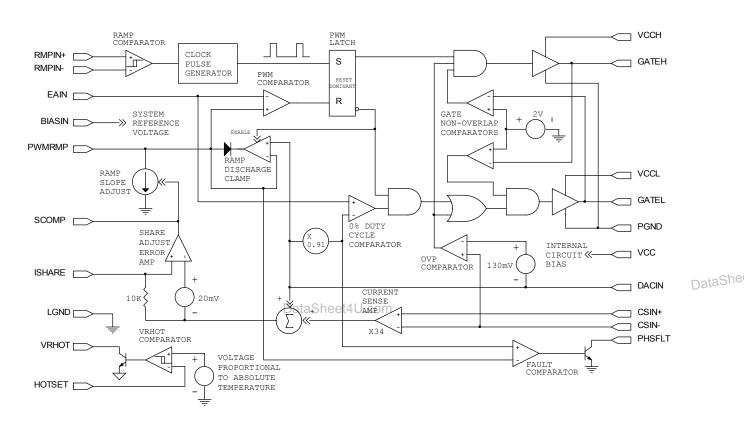


Figure 6 – IR3086 Block Diagram

#### **Tri-State Gate Drivers**

The gate drivers can deliver up to 3A peak current. An adaptive non-overlap circuit monitors the voltage on the GATEH and GATEL pins to prevent MOSFET shoot-through current while minimizing body diode conduction.

An Enable signal is provided by the Control IC to the Phase IC without the additional of a dedicated signal line. The Error Amplifier output of the Control IC drives low in response to any fault condition such as input under voltage or output overload. The IR3086 0% duty cycle comparator detects this and drives both gate outputs low. This tri-state operation prevents negative inductor current and negative output voltage during power-down.

The Gate Drivers revert to a high impedance "off" state at VCCL and VCCH supply voltages below the normal operating range. An  $80k\Omega$  resistor is connected across the GATEX and PGND pins to prevent the GATEX voltage from rising due to leakage or other cause under these conditions.

taSheet4U.com www.DataSheet4U.com

Page 11 of 15 9/1/03

International

TOR Rectifier

**IR3086** 

## Over Voltage Protection (OVP)

The IR3086 includes over-voltage protection that turns on the low side MOSFET to protect the load in the event of a shorted high-side MOSFET or connection of the converter output to an excessive output voltage. A comparator monitors the voltage at the CSIN- pin which is usually connected directly to the converter output. If the voltage exceeds the DACIN voltage plus 130mV the GATEL pin drives high. The OVP circuit over-rides the normal PWM operation and will fully turn-on the low side MOSFET within approximately 150ns. The low side MOSFET will remain ON until the over-voltage condition ceases.

When designing for OVP the overall system must be considered. In many cases the over-current protection of the AC-DC or DC-DC converter supplying the multiphase converter will be triggered thus providing effective protection without damage as long as all PCB traces and components are sized to handle the worst-case maximum current. If this is not possible a fuse can be added in the input supply to the multiphase converter. One scenario to be careful of is where the input voltage to the multiphase converter may be pulled below the level where the ICs can provide adequate voltage to the low side MOSFET thus defeating OVP.

Dynamic changes in the VID code to a lower output voltage may trigger OVP. For example; a 250mV decrease in output voltage combined with a light load condition will cause the low side MOSFETs to turn on and interfere with Body Braking<sup>TM</sup>. This will not cause a problem however as Body Braking<sup>TM</sup> will resume once the output voltage is less than 130mV above the VID voltage.

et4U.com

nataShe

Excessive distribution impedance between the converter and load or programming of the converter output voltage above the VID voltage may trigger OVP during normal operation. If the voltage dropped across the distribution impedance exceeds the minimum OVP comparator threshold of 100mV plus any voltage positioning the IR3086 can not be used. For example; a converter having 25mV of VID offset, 125mV of AVP at full load, and 75mV of drop in the distribution path at full load would be OK since 100mV + 25mV + 125mV = 250mV which is greater than 75mV. The IR3088 Phase IC without OVP should be used in applications with excessive distribution impedance.

## Thermal Monitoring (VRHOT)

The IR3086 senses its own die temperature and produces a voltage at the input of the VRHOT comparator that is proportional to temperature. An external resistor divider connected from VBIAS to the HOTSET pin and ground can be used to program the thermal trip point of the VRHOT comparator. The VRHOT pin is an open-collector output and should be pulled up to a voltage source through a resistor. If the thermal trip point is reached the VRHOT output drives low.

#### **Phase Fault**

Its possible for multiphase converters to appear to be working correctly with one or more phases not functioning. The output voltage can still be regulated and the full load current may still be delivered. However, the remaining phase(s) will be stressed far beyond their intended design limits and are likely to fail. Loss of a phase can occur due to poor solder connections or mounting during the manufacturing process, or can occur in the field. The most common failure mode of a buck converter is failure of the high side MOSFET.

DataSheet4U.com www.DataSheet4U.com

Page 12 of 15 9/1/03

DataSheet4U.com

**IR3086** 

The IR3086 has the ability to detect if a phase stops switching and can provide this information to the system through the PHSFLT output pin. If a phase stops switching its output current will drop to zero and the output of its IR3086 current sense amp will be the DACIN voltage. The Share Adjust Amplifier reacts to this by increasing the Ramp Slope Adjust current until it exceeds the externally programmable PWM Ramp bias current. This will cause the voltage at the PWMRMP pin to drop below its normal operating range. The Fault Comparator trips and drives the PHSFLT output to ground when the voltage on the PWMRMP pin falls below 91% of the DACIN voltage. PHSFLT is an open-collector output and should be pulled up to a voltage source through a resistor.

## APPLICATIONS INFORMATION

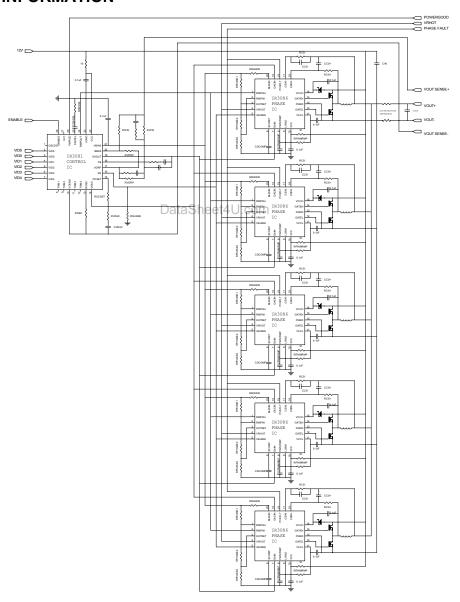


Figure 7 – 5 Phase IR3081/3086 EVRD10 Converter

DataSheet4U.com www.DataSheet4U.com

Page 13 of 15 9/1/03

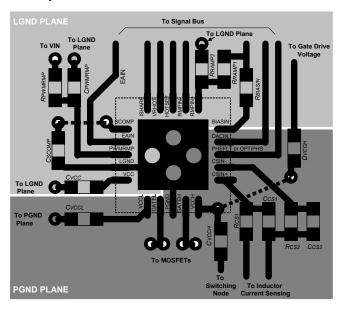
DataSheet4U.com

DataShee

## LAYOUT GUIDELINES

The following layout guidelines are recommended to reduce the parasitic inductance and resistance of the PCB layout, therefore minimizing the noise coupled to the IC.

- Dedicate at least one middle layer for a ground plane, which is then split into signal ground plane (LGND) and power ground plane (PGND).
- Connect PGND to LGND pins of each phase IC to the ground tab under it.
- In order to reduce the noise coupled to SCOMP pin of phase ICs, use a dedicated wire to connect the capacitor CSCOMP to LGND pin, but connect PWM ramp capacitor CPWMRMP, phase delay programming resistor RRAMP2, decoupling capacitor CVCC to LGND plane through vias.
- Connect the decoupling capacitor low side gate driver CVCCL and the ground tab under the phase IC to PGND plane through vias.
- Place the decoupling capacitor CVCC as close as possible to VCC pin of the control IC, and place the decoupling capacitors CVCC and CVCCL as close as possible to VCC and VCCL pins of the phase IC respectively.
- Bus signals should not cross over the fast transition nodes, such as switching nodes and gate drive output.
- Use Kelvin connections for the current sense signals, and use the ground plane to shield the current sense traces. DataShe
- Place the phase ICs as close as possible to the MOSFETs to reduce the parasitic resistance and inductance of the gate drive paths.
- Place the input capacitors close to the drain of top MOSFET and the source of bottom MOSFET. Replace the bigger-package ceramic capacitors with multiple smaller-package ones to reduce the parasitic inductance.
- There are two switching power loops. One loop includes the input capacitors, top MOSFET, inductor, output capacitors and the load; another loop consists of bottom MOSFET, inductor, output capacitors and the load. Route the switching power paths using wide and short traces or polygons; use multiple vias for connections between layers.



et4U.com

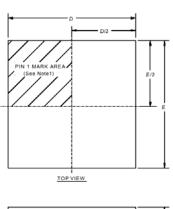
Figure 8 - Layout of Phase IC Components

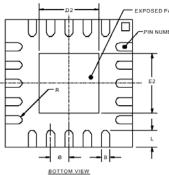
Page 14 of 15 9/1/03



## PACKAGE INFORMATION

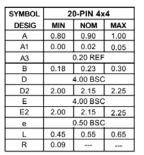
## 20L MLPQ (4 x 4 mm Body) $-\theta_{JA} = 32^{\circ}C/W$ , $\theta_{JC} = 3^{\circ}C/W$



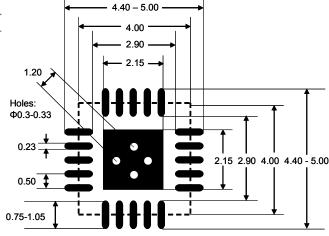


SIDE VIEW A1

Note 1: Details of pin #1 are optional, but must be located within the zone indicated. The identifier may be molded, or marked features.



NOTE: ALL MEASUREMENTS ARE IN MILLIMETERS.



Note: All dimensions are in Millimeters.

Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market.

Qualification Standards can be found on IR's Web site.



IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105

TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information 4U.com

DataSheet4U.com.irf.com

Page 15 of 15 9/1/03